TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74HCT374AP, TC74HCT374AF

Octal D-Type Flip-Flop with 3-State Output

The TC74HCT374A is high speed CMOS OCTAL FLIP-FLOP with 3-STATE OUTPUT fabricated with silicon gate  $\rm C^2MOS$  technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

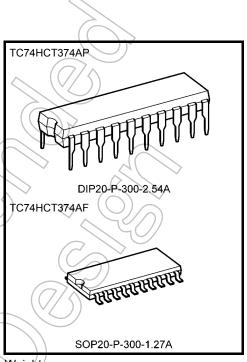
Their inputs are compatible with TTL, NMOS, and CMOS output voltage levels.

This 8-bit D-type flip-flop is controlled by a clock input (CK) and an output enable input ( $\overline{OE}$ ).

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

#### **Features**

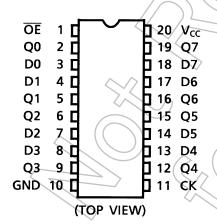
- High speed:  $f_{max} = 62 \text{ MHz}$  (typ.) at  $V_{CC} = 5 \text{ V}$
- Low power dissipation:  $I_{CC} = 4 \mu A \text{ (max)}$  at  $T_{a} = 25^{\circ}C$
- Wide interfacing ability: LSTTL, NMOS, CMOS
- Output drive capability: 15 LSTTL loads
- Symmetrical output impedance: |IOH| = IOL = 6 mA (min)
- Balanced propagation delays:  $t_{pLH} \simeq t_{pHL}$
- Pin and function compatible with 74LS374



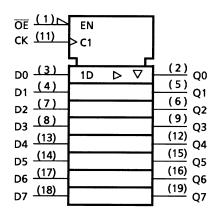
Weight

DIP20-P-300-2.54A : 1.30 g (typ.) SOP20-P-300-1.27A : 0.22 g (typ.)

#### **Pin Assignment**



# **IEC Logic Symbol**



### **Truth Table**

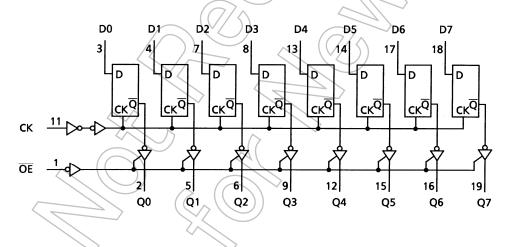
	Output					
ŌĒ	CK	D	Q			
Н	Х	Х	Z			
L	$\neg$	Х	Qn			
L		L	L			
L		Н	Н			

X: Don't care

Z: High impedance

Qn: No change

## **System Diagram**



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## **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	–0.5 to 7	V
DC input voltage	V <sub>IN</sub>	−0.5 to V <sub>CC</sub> + 0.5	V
DC output voltage	Vout	-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	lικ	±20	mA
Output diode current	lok	±20	mA
DC output current	lout	±35	mA )
DC V <sub>CC</sub> /ground current	Icc	±75	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP)	/mW
Storage temperature	T <sub>stg</sub>	-65 to 150	$\bigcirc c$

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to 65°C. From Ta = 65 to 85°C a derating factor of -10 mW/°C shall be applied until 300 mW.

## **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage	Vcc	4.5 to 5.5	V
Input voltage	VIN	0 to V <sub>CC</sub>	٧
Output voltage	Уоит	0 to V <sub>CC</sub>	٧
Operating temperature	(Topr))	-40 to 85	°C
Input rise and fall time	t <sub>i</sub> , t <sub>f</sub>	0 to 500	ns

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V<sub>CC</sub> or GND.

#### **Electrical Characteristics**

#### **DC Characteristics**

Characteristics	Symbol	Test Condition			Ta = 25°C			Ta = -40 to 85°C		Unit
		(4)	d		Min	Тур.	Max	Min	Max	
High-level input voltage	VIH (	· ()		4.5 to 5.5	2.0	_	ı	2.0		V
Low-level input voltage	VIL			4.5 to 5.5			0.8	l	0.8	٧
High-level output	High-level output		$I_{OH} = -20 \mu A$	4.5	4.4	4.5	_	4.4	_	V
voltage V <sub>OH</sub>		= V <sub>IH</sub> or V <sub>IL</sub>	$I_{OH} = -6 \text{ mA}$	4.5	4.18	4.31	_	4.13	_	V
Low-level output	Low-level output voltage	$V_{IN}$	$I_{OL} = 20 \mu A$	4.5	_	0.0	0.1	_	0.1	V
voltage		= V <sub>IH</sub> or V <sub>IL</sub>	$I_{OL} = 6 \text{ mA}$	4.5		0.17	0.26		0.33	V
3-state output off-state current	loz	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>OUT</sub> = V <sub>CC</sub> or GND		5.5			±0.5		±5.0	μΑ
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	l		±0.1		±1.0	μΑ
Quiescent supply	Icc	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5		_	4.0		40.0	μΑ
current	IC	$I_C$ Per input: $V_{IN} = 0$ Other input: $V_{CC}$		5.5	_	_	2.0	_	2.9	mA



#### Timing Requirements (input: $t_r = t_f = 6$ ns)

Characteristics Symbol		Test Condition	Ta =	25°C	Ta = -40 to 85°C	Unit	
			V <sub>CC</sub> (V)	Тур.	Limit	Limit	
Minimum pulse width	t <sub>W (H)</sub>		4.5	_	15	19	20
(CK)	t <sub>W (L)</sub>	_	5.5	$\langle \cdot \rangle$	14	17	ns
Minimum set-up time			4.5	->	15	19	
(Dn)	t <sub>s</sub>	_	5.5	+(	14	17	ns
Minimum hold time			4.5		0	0	
(Dn)	t <sub>h</sub>	_	<b>5.5</b>	(///5)	0	0	ns
		4.5		31	25	MII-	
Clock frequency	Γ	_	5.5	)~	37	30	MHz

## AC Characteristics (input: $t_r = t_f = 6$ ns)

Characteristics	Symbol Test Cond		radition Ta = 25°C					Ta = -40 to 85°C		
			CL (pF)	V <sub>CC</sub> (V)	Min	Typ.	Max	(Min	Max	
Output transition time	t <sub>TLH</sub>		50	4.5	_	7	7 12		15	ns
Output transition time	t <sub>THL</sub>		37/	5.5		6	(11)	_	14	115
_			50	4.5	_	20	30	_	38	
Propagation delay time	t <sub>pLH</sub>		3	5.5	1	(17)	25	_	31	ns
(CK-Q)	$t_{pHL}$	_ 4(	150	4.5		25	38		48	113
,			150	5.5		22	33	_	41	
		$((\ ))$	50	4.5		/17	30	_	38	
Output enable time	$t_{pZL}$	$R_L = 1 \text{ K}\Omega$	30	5.5		14	25	_	31	ns
Output chable time	t <sub>pZH</sub>	TIL TIME	150	4.5	_	25	38	_	48	113
			130	5.5	$\rangle$ —	19	33	_	41	
Output disable time	t <sub>pLZ</sub>	$R_L = 1 k\Omega$	50	4.5	_	16	28	_	35	ns
Output disable time	(t <sub>pHZ</sub> )	1/1/22	(07/	<b>5.5</b>	_	14	24	_	30	113
Maximum clock			50	4.5	31	50	_	25	_	MHz
frequency	fmax		3/	5.5	37	59	_	30		IVII IZ
Input capacitance	C <sub>IN</sub>		-			5	10		10	pF
Output capacitance	Cout		$\rightarrow$		_	10	_	_	_	pF
Power dissipation	$c_{PD}$	~()				48				nE
capacitance	(Note)		-			40				pF

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

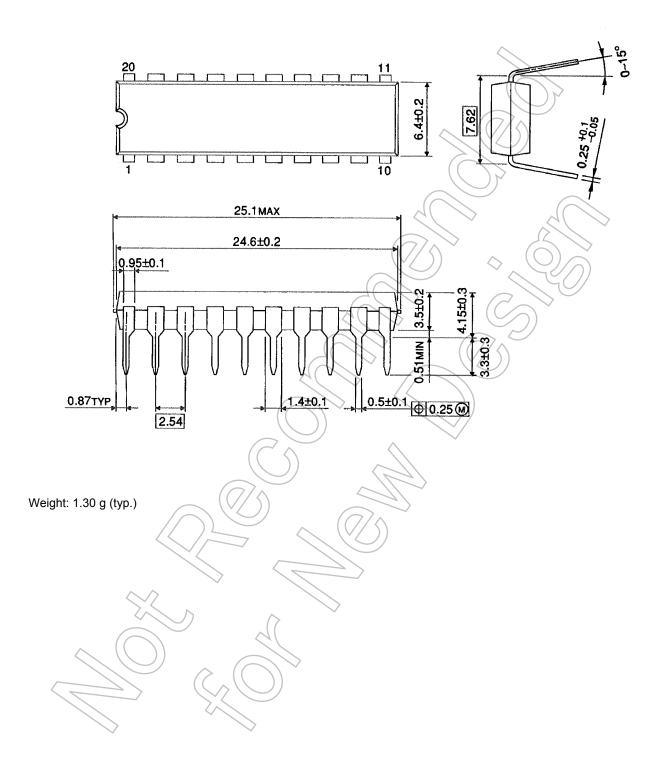
 $I_{CC}$  (opr) =  $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8$  (per F/F)

And the total CPD when n pcs. of flip flop operate can be gained by the following equation:

 $C_{PD}$  (total) = 30 + 18 · n

# **Package Dimensions**

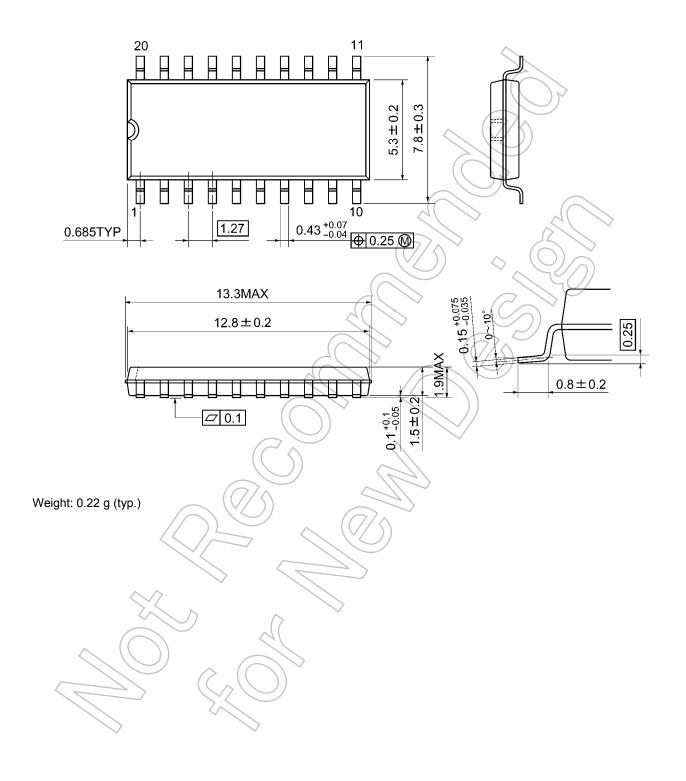
DIP20-P-300-2.54A Unit: mm





# **Package Dimensions**

SOP20-P-300-1.27A Unit: mm



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